

SN54HC377, SN74HC377 OCTAL D-TYPE FLIP-FLOPS WITH CLOCK ENABLE

SCLS307B–JANUARY 1996 – REVISED JANUARY 2003

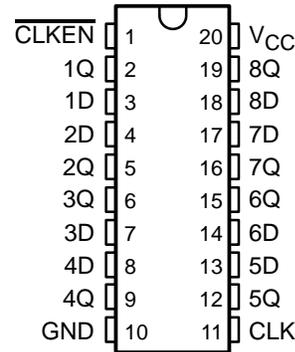
- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80- μ A Max I_{CC}
- Typical $t_{pd} = 12$ ns
- ± 4 -mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- Eight Flip-Flops With Single-Rail Outputs
- Clock Enable Latched to Avoid False Clocking
- Applications Include:
 - Buffer/Storage Registers
 - Shift Registers
 - Pattern Generators

description/ordering information

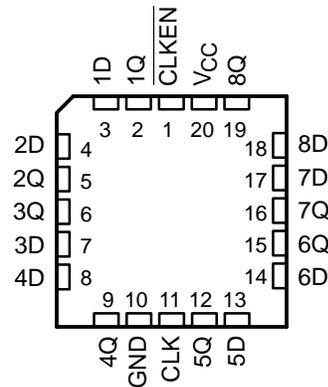
These devices are positive-edge-triggered octal D-type flip-flops with an enable input. The 'HC377 devices are similar to the 'HC273 devices, but feature a latched clock-enable (CLKEN) input instead of a common clear.

Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock (CLK) pulse, if CLKEN is low. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input has no effect at the output. These devices are designed to prevent false clocking by transitions at CLKEN.

SN54HC377 . . . J OR W PACKAGE
SN74HC377 . . . DW, N, OR NS PACKAGE
(TOP VIEW)



SN54HC377 . . . FK PACKAGE
(TOP VIEW)



ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|-----------------------|------------------|
| –40°C to 85°C | PDIP – N | Tube | SN74HC377N | SN74HC377N |
| | SOIC – DW | Tube | SN74HC377DW | HC377 |
| | | Tape and reel | SN74HC377DWR | |
| | SOP – NS | Tape and reel | SN74HC377NSR | HC377 |
| –55°C to 125°C | CDIP – J | Tube | SNJ54HC377J | SNJ54HC377J |
| | CFP – W | Tube | SNJ54HC377W | SNJ54HC377W |
| | LCCC – FK | Tube | SNJ54HC377FK | SNJ54HC377FK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

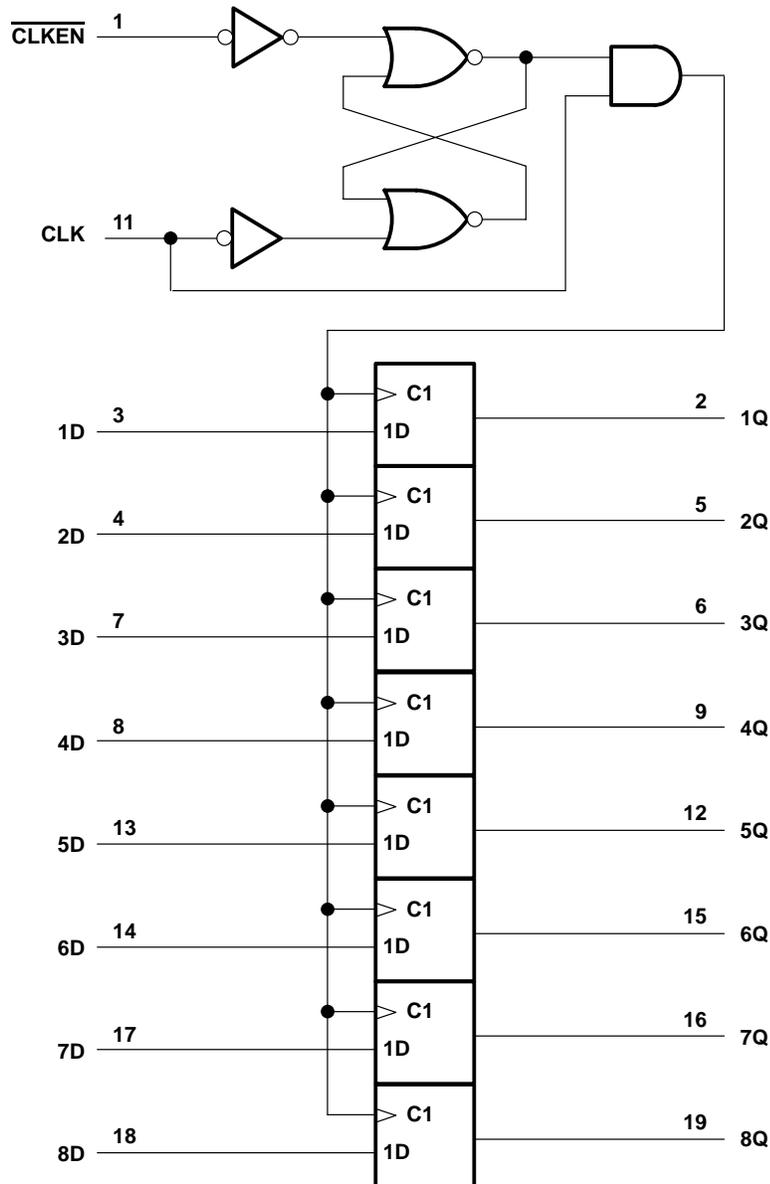
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FUNCTION TABLE
(each flip-flop)

| INPUTS | | | OUTPUT |
|--------|-----|---|----------------|
| CLKEN | CLK | D | Q |
| H | X | X | Q ₀ |
| L | ↑ | H | H |
| L | ↑ | L | L |
| X | L | X | Q ₀ |

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) | ±20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V_{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DW package | 58°C/W |
| N package | 69°C/W |
| NS package | 60°C/W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

| | | SN54HC377 | | | SN74HC377 | | | UNIT |
|---------------------|---------------------------------|------------------|-----|----------|------------------|------------------|----------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} | Supply voltage | 2 | 5 | 6 | 2 | 5 | 6 | V |
| V_{IH} | High-level input voltage | $V_{CC} = 2$ V | | 1.5 | $V_{CC} = 2$ V | | 1.5 | V |
| | | $V_{CC} = 4.5$ V | | 3.15 | $V_{CC} = 4.5$ V | | 3.15 | |
| | | $V_{CC} = 6$ V | | 4.2 | $V_{CC} = 6$ V | | 4.2 | |
| V_{IL} | Low-level input voltage | $V_{CC} = 2$ V | | | 0.5 | $V_{CC} = 2$ V | | 0.5 |
| | | $V_{CC} = 4.5$ V | | | 1.35 | $V_{CC} = 4.5$ V | | 1.35 |
| | | $V_{CC} = 6$ V | | | 1.8 | $V_{CC} = 6$ V | | 1.8 |
| V_I | Input voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| V_O | Output voltage | 0 | | V_{CC} | 0 | | V_{CC} | V |
| $\Delta t/\Delta v$ | Input transition rise/fall time | $V_{CC} = 2$ V | | | 1000 | $V_{CC} = 2$ V | | 1000 |
| | | $V_{CC} = 4.5$ V | | | 500 | $V_{CC} = 4.5$ V | | 500 |
| | | $V_{CC} = 6$ V | | | 400 | $V_{CC} = 6$ V | | 400 |
| T_A | Operating free-air temperature | –55 | | 125 | –40 | | 85 | °C |

NOTE 3: All unused inputs of the device must be held at VCC or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | V _{CC} | T _A = 25°C | | | SN54HC377 | | SN74HC377 | | UNIT |
|-----------------|---|--------------------------|-----------------|-----------------------|-------|------|-----------|-------|-----------|-------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | V _I = V _{IH} or V _{IL} | I _{OH} = -20 μA | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | V | |
| | | | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| | | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | |
| | | I _{OH} = -4 mA | 4.5 V | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | | 6 V | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| V _{OL} | V _I = V _{IH} or V _{IL} | I _{OL} = 20 μA | 2 V | | 0.002 | 0.1 | | 0.1 | | V | |
| | | | 4.5 V | | 0.001 | 0.1 | | 0.1 | | | 0.1 |
| | | | 6 V | | 0.001 | 0.1 | | 0.1 | | | 0.1 |
| | | I _{OL} = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | | 0.33 |
| | | | 6 V | | 0.15 | 0.26 | | 0.4 | | | 0.33 |
| I _I | V _I = V _{CC} or 0 | | 6 V | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA |
| I _{CC} | V _I = V _{CC} or 0, I _O = 0 | | 6 V | | | 8 | | 160 | | 80 | μA |
| C _i | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | pF |

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

| | | V _{CC} | T _A = 25°C | | SN54HC377 | | SN74HC377 | | UNIT | |
|--------------------|---------------------------------|--------------------------------|-----------------------|-----|-----------|-----|-----------|-----|------|----|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | | |
| f _{clock} | Clock frequency | 2 V | | 5 | | 3 | | 4 | MHz | |
| | | 4.5 V | | 25 | | 16 | | 20 | | |
| | | 6 V | | 29 | | 19 | | 23 | | |
| t _w | Pulse duration, CLK high or low | 2 V | | 100 | | 150 | | 125 | ns | |
| | | 4.5 V | | 20 | | 30 | | 25 | | |
| | | 6 V | | 17 | | 25 | | 21 | | |
| t _{su} | Setup time before CLK↑ | D | 2 V | | 100 | | 150 | | 125 | ns |
| | | | 4.5 V | | 20 | | 30 | | 25 | |
| | | | 6 V | | 17 | | 25 | | 21 | |
| | CLKEN high or low | 2 V | | 100 | | 150 | | 125 | | |
| | | 4.5 V | | 20 | | 30 | | 25 | | |
| | | 6 V | | 17 | | 25 | | 21 | | |
| t _h | Hold time after CLK↑ | CLKEN inactive or active, data | 2 V | | 5 | | 5 | | 5 | ns |
| | | | 4.5 V | | 5 | | 5 | | 5 | |
| | | | 6 V | | 5 | | 5 | | 5 | |



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switching characteristics over recommended operating free-air temperature range, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} | T _A = 25°C | | | SN54HC377 | | SN74HC377 | | UNIT |
|------------------|--------------|-------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | 2 V | 5 | 11 | | 3 | | 4 | MHz | |
| | | | 4.5 V | 25 | 54 | | 16 | | 20 | | |
| | | | 6 V | 29 | 64 | | 19 | | 23 | | |
| t _{pd} | CLK | Any | 2 V | | 56 | 160 | | 240 | | 200 | ns |
| | | | 4.5 V | | 15 | 32 | | 48 | | 40 | |
| | | | 6 V | | 12 | 27 | | 41 | | 34 | |
| t _t | | Any | 2 V | | 38 | 75 | | 110 | | 95 | ns |
| | | | 4.5 V | | 8 | 15 | | 22 | | 19 | |
| | | | 6 V | | 6 | 13 | | 19 | | 16 | |

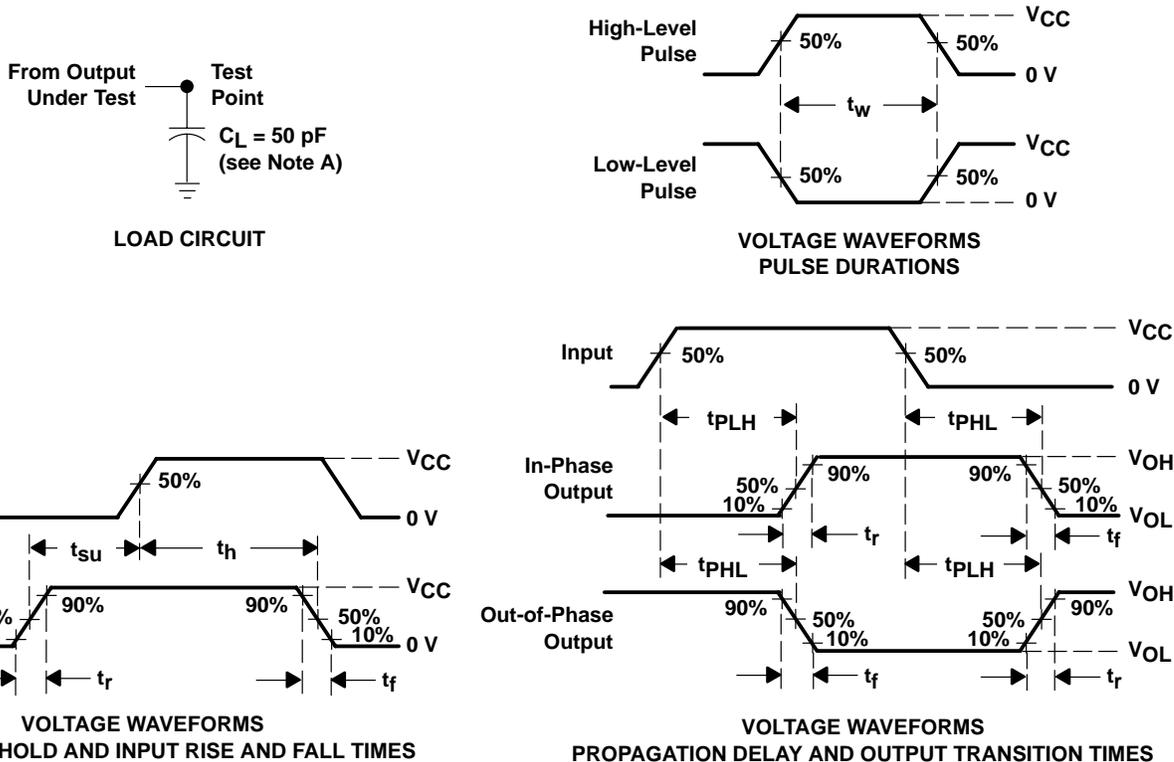
operating characteristics, T_A = 25°C

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|---|-----------------|-----|------|
| C _{pd} Power dissipation capacitance per flip-flop | No load | 30 | pF |

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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 - C. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|---------------------|--------------------------------------|----------------------|--------------|--|-------------------------|
| 5962-87807012A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 87807012A SNJ54HC 377FK | Samples |
| 5962-8780701RA | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8780701RA SNJ54HC377J | Samples |
| SN54HC377J | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN54HC377J | Samples |
| SN74HC377DW | ACTIVE | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HC377 | Samples |
| SN74HC377DWR | ACTIVE | SOIC | DW | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HC377 | Samples |
| SN74HC377N | ACTIVE | PDIP | N | 20 | 20 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | SN74HC377N | Samples |
| SN74HC377NE4 | ACTIVE | PDIP | N | 20 | 20 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | SN74HC377N | Samples |
| SN74HC377NSR | ACTIVE | SO | NS | 20 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HC377 | Samples |
| SNJ54HC377FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 87807012A SNJ54HC 377FK | Samples |
| SNJ54HC377J | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-8780701RA SNJ54HC377J | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

- (3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54HC377, SN74HC377 :

- Catalog: [SN74HC377](#)
- Military: [SN54HC377](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74HC377DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| SN74HC377NSR | SO | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

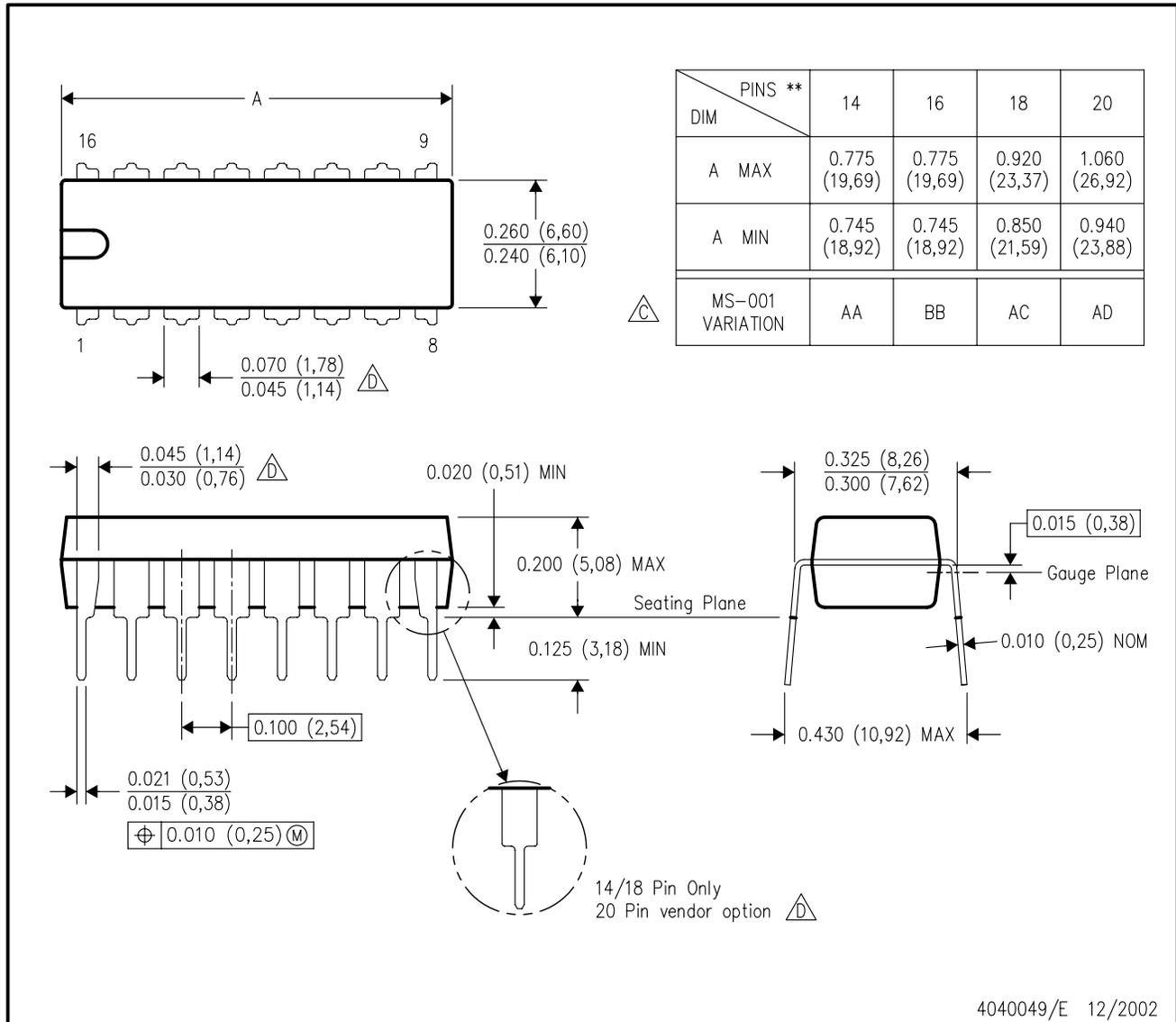

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HC377DWR | SOIC | DW | 20 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74HC377NSR | SO | NS | 20 | 2000 | 367.0 | 367.0 | 45.0 |

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - $\triangle D$ The 20 pin end lead shoulder width is a vendor option, either half or full width.

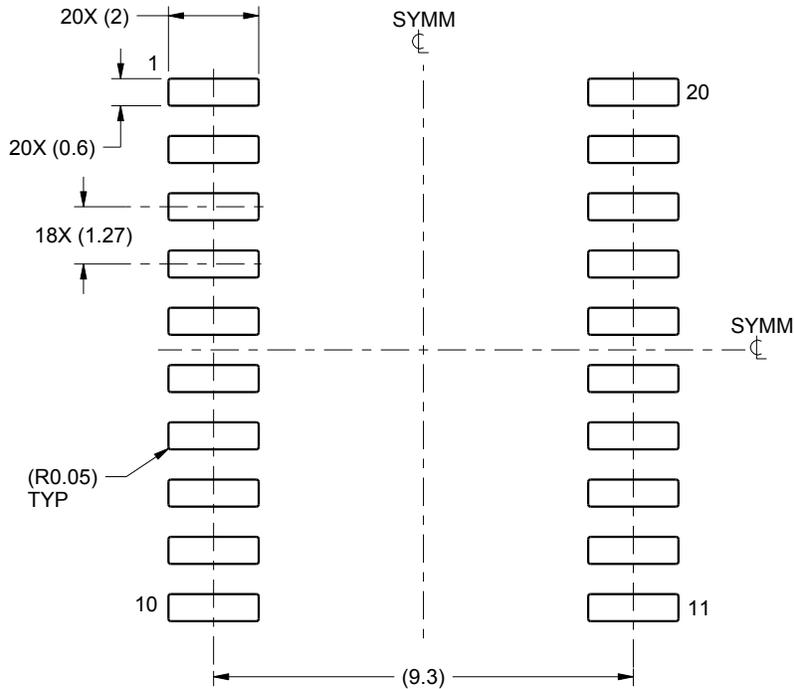
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EXAMPLE BOARD LAYOUT

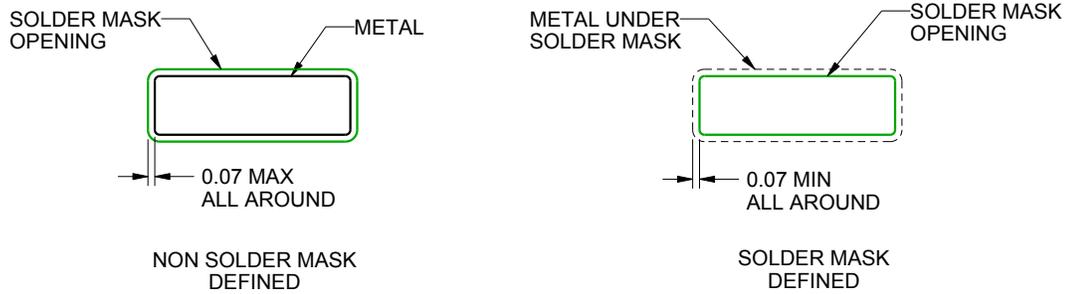
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

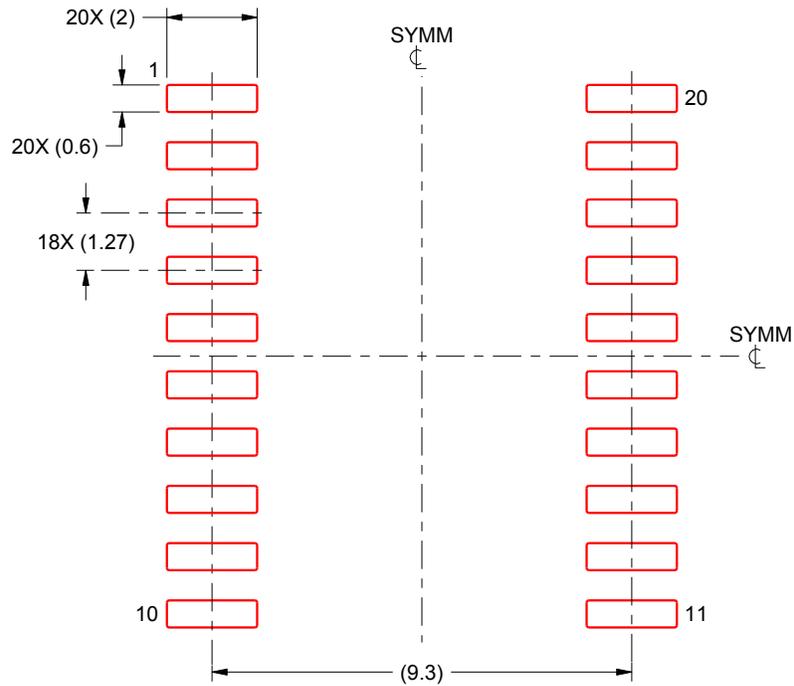
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

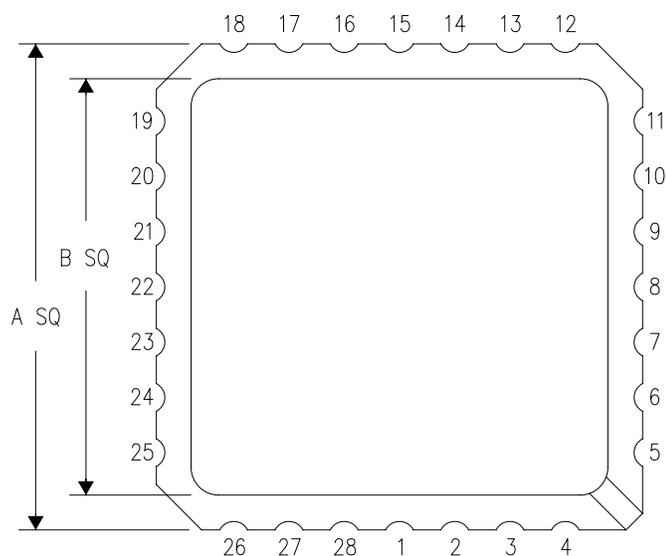
NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

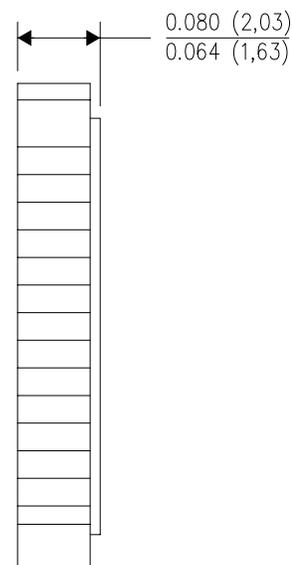
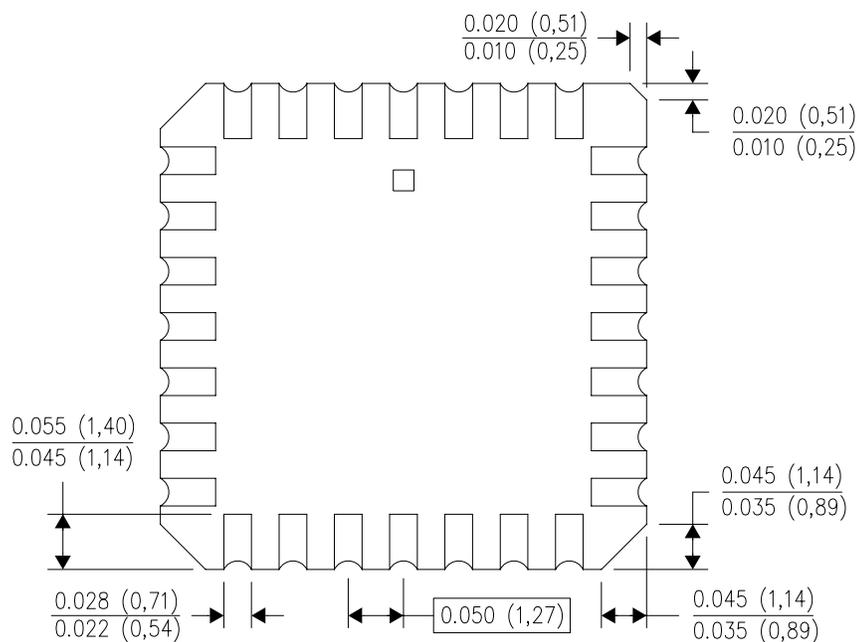
FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A | | B | |
|---------------------|------------------|------------------|------------------|------------------|
| | MIN | MAX | MIN | MAX |
| 20 | 0.342 (8,69) | 0.358 (9,09) | 0.307 (7,80) | 0.358 (9,09) |
| 28 | 0.442 (11,23) | 0.458 (11,63) | 0.406 (10,31) | 0.458 (11,63) |
| 44 | 0.640 (16,26) | 0.660 (16,76) | 0.495 (12,58) | 0.560 (14,22) |
| 52 | 0.740 (18,78) | 0.761 (19,32) | 0.495 (12,58) | 0.560 (14,22) |
| 68 | 0.938 (23,83) | 0.962 (24,43) | 0.850 (21,6) | 0.858 (21,8) |
| 84 | 1.141 (28,99) | 1.165 (29,59) | 1.047 (26,6) | 1.063 (27,0) |



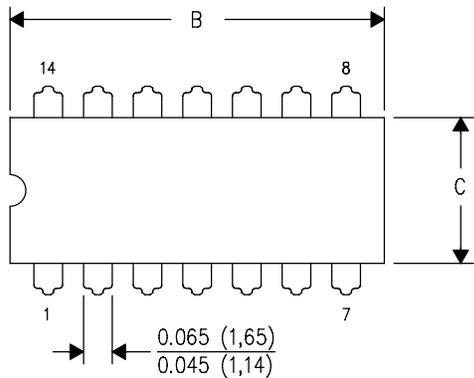
4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

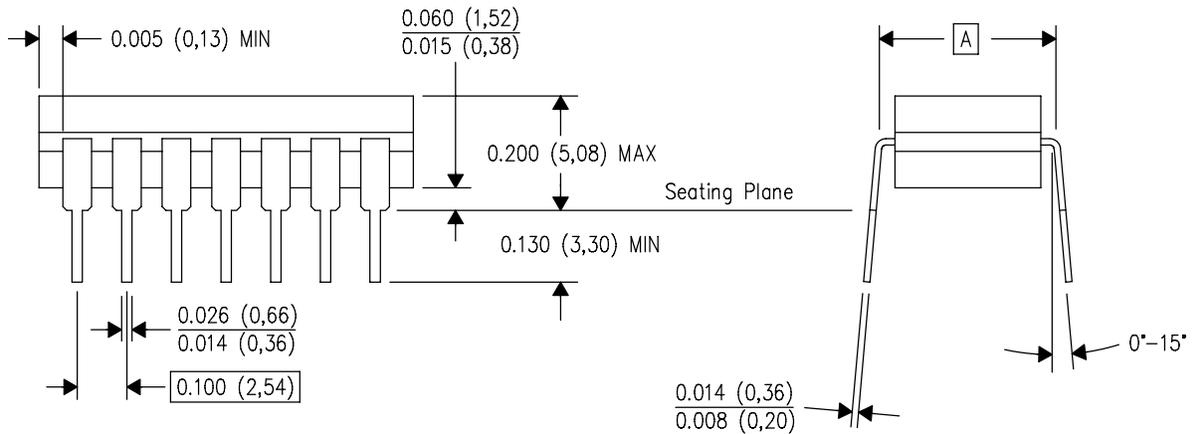
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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